703-684-1157

ASA-5780

PATENTS ONLY (ref OG 7/28/92)

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original document or copy thereof.

ı.	Name of Party(ies interest:) conveying an	2.	Name and Address of Party(ies) receiving an interest:
	Isao SAKAMA Minoru ASHIZAWA	(6/15,07) (6/13/07)		HITACHI, LTD. 6-6, Marunouchi 1~chome Chiyoda-ku, Tokyo, JAPAN

3. Description of the interest conveyed: Assignment

4. Application number(s) or patent number(s).

Additional sheet attached? ____ Yes XXX No

If this document is being filed together with a new application, the execution date of the application is: _______ DATE

A. Patent Application No.(s) B. Patent No.(s)

11/741,012

5. Name and address of party to whom correspondence concerning document should be mailed:

John R. Mattingly Mattingly, Stanger, Malur& Brundidge, P.C. 1800 Diagonal Road, Suite 370 Alexandria, Virginia 22314

- 6. Number of applications and patents involved: One
- 7. Amount of fee enclosed or authorized to be charged: <u>\$40.00</u>
- 8. The Commissioner is hereby authorized to charge Deposit Account No. 50-1417 if no credit card payment form is attached.

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- 9. Execution date of attached document: June 13 & 15, 2007
- 10. To the best of my knowledge and belief, I declare under penalty of perjury under the laws of the United States of America that the foregoing information is true and correct and that any attached copy is a true copy of the original document.

Sion

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July 6, 2007 Date

Total number of pages being submitted:

Shrinath Malur

Name of Person Signing

703-684-1157

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi, Ltd.,

a corporation organized under the laws of Japan,

located at 6-6, Marunouchi 1-chome, Chiyoda-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said. Hitachi, Ltd.,

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Hitachi, Ltd.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi, Ltd.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) Date Signed (発明者フルネームサイン) (署名日) Jane, 15, 200 ; 19awa June 13, 2007 minony 3) 4) _____ 5) _____ 6) 7) _____ 8) ····· 9) 10) PATENT **RECORDED: 07/06/2007** REEL: 019526 FRAME: 0785